

SPECIFICATIONS

MXM 3.0 Socket

Mechanical

Contact Retention Force: 0.10kg min.

Durability : 25 Cycles

Electrical

Voltage Rating: 25V

Current Rating: 0.5A

Contact Resistance: 55mΩ max.

Dielectric Withstanding Voltage: 200V AC/1 min.

Insulation Resistance: 100MΩ

Physical

Housing: Thermoplastic, UL 94V-0 rated in Ivory Color

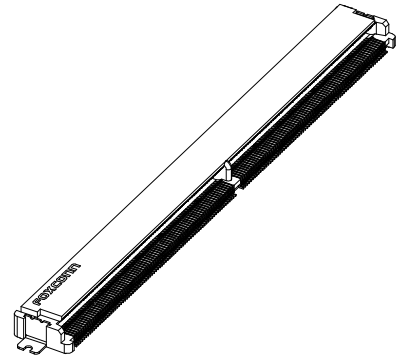
Contact: Copper alloy

Plating: See "ORDERING INFORMATION"

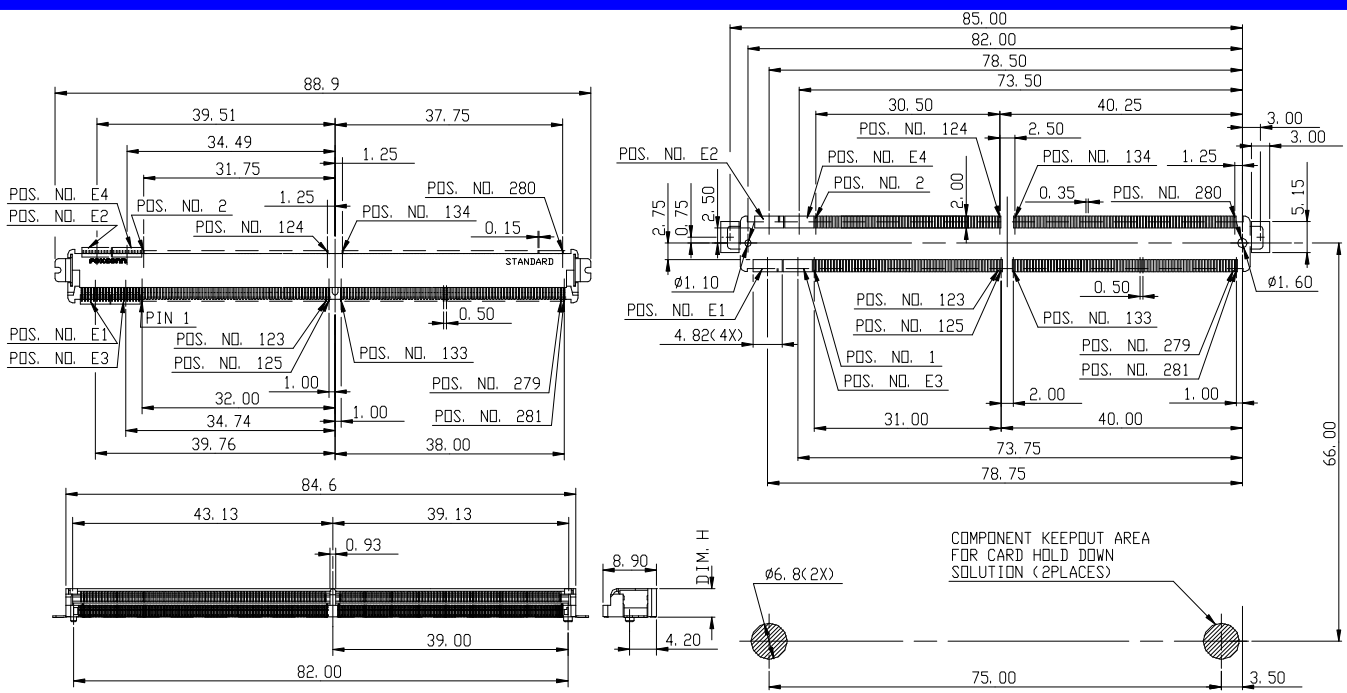
Metal Spring: Copper alloy

Operating Temperature: -55℃ to +85℃

AS Series
4.3mm&5.5mm&
7.8mm Height
SMT Type
0.50mm Pitch
314 Pos.



DRAWING



RECOMMENDED PCB LAYOUT

ORDERING INFORMATION

PRODUCT NO.: **AS0B82*-S**B-*H**

Memory Module Socket

Horizontal Type

Single Row

No. of Pos.
B8=314Pos.

SMT Type

Contact Area Plating
1=Gold Flash
6=10u" Gold plating

H=Halogen/Lead Free

Package Code
4=Soft Tray
7=Carrier tape

B=Black Color

43=4.3mm Height
55=5.5mm Height
78=7.8mm Height

S=Standard Type

AS0B82*-S43B-*H	4.3
AS0B82*-S55B-*H	5.5
AS0B82*-S78B-*H	7.8
P/N	DIM. H